g	GI	Energy	Functional Testing Specification
	Parts & Repair Services Louisville, KY		LOU-GED-531X185CPTA

# Test Procedure for a 531X185CPTA

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DATE	DATE	DATE	DATE
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REV. A

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### 1. SCOPE

1.1 This is a functional testing procedure for a

# 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

- **3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.
  - **3.1.1** Check board's electronic folder for more information

# 4. **ENGINEERING REQUIREMENTS**

- 4.1 Equipment Cleaning
  - **4.1.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to site specific SRA's for cleaning guidelines.
- **4.2** Equipment Inspection
  - **4.2.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
    - 4.2.1.1 Wires broken, cracked, or loosely connected
    - 4.2.1.2 Terminal strips / connectors broken or cracked
    - 4.2.1.3 Components visually damaged
    - **4.2.1.4** Capacitors bloated or leaking
    - 4.2.1.5 Solder joints damaged or cold
    - 4.2.1.6 Circuit board burned or de-laminated
    - 4.2.1.7 Printed wire runs / Traces burned or damaged

## 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1		Fluke 85 or Equivalent
1		SCR Firing Box
1		Oscilloscope

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## 6. Testing Process

- 6.1 Resistance checks
  - **6.1.1** Remove jumpers at JP3, JP4, and JP5.
  - **6.1.2** Measure from NFB1 to L1 for 3.75M ohm.
  - **6.1.3** Measure from NFB2 to L2 for 3.75M ohm.
  - **6.1.4** Measure from NFB3 to L3 for 3.75M ohm.
  - **6.1.5** DMM set to diode scale.
  - **6.1.6** Measure from L1 (+) to CPSR (-) for 1.5V
  - **6.1.7** Measure from L2 (+) to CPSR (-) for 1.5V
  - **6.1.8** Measure from L3 (+) to CPSR (-) for 1.5V
  - **6.1.9** Measure R38-R43 and R67 for 20 ohms.
  - **6.1.10** Measure R68-R69 for 1 ohm.
  - **6.1.11** Component test all snubber caps.
  - **6.1.12** Verify fuses are operational and they are of proper value.
- 6.2 Power On Test
  - 6.2.1 Connect +24Vdc to pin 16 and com. to pin 14 (PCOM) of connector NFB.
  - **6.2.2** Use the chart below to test the firing circuit of the card. Set scope at 5V per/div. and 1ms/div.

<b>SCR Firing Box</b>	<b>SCR Firing Box</b>	Scope (+)	Scope (-)	LED
NPT 13	PCOM	1SP2	1SP1	No
NPT 14	PCOM	1NP2	1NP1	LED A
NPT 15	PCOM	2SP2	2SP1	No
NPT 16	PCOM	2NP2	2NP1	LED B
NPT 17	PCOM	3SP2	3SP1	No
NPT 18	PCOM	3NP2	3NP1	LED C

- **6.2.3** Connect a 33 ohm 5w resistor (for a load) to each of the output circuits (1S-3S) as you test them
- **6.2.4** You will observe an approximant 12V p/p positive pulse train on each of the output circuits
- **6.2.5** The LEDs A, B and C will illuminate in intensity with the varying of the SCR firing box.
- 6.3 \*\*\*TEST COMPLETE \*\*\*

## 7. Notes & Attachments

7.1 None at this time.